

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings of claims in the application:

Listing of Claims:

1 1. (Currently Amended) A metal identification platelet ~~(1)~~ equipped with an
2 identification code, ~~characterized by the fact, that~~ wherein the identification code comprises a
3 hologram ~~(2)~~.

1 2. (Currently Amended) The metal identification platelet ~~(1)~~ as in Claim 1,
2 ~~characterized by the fact, that~~ wherein the identification code further comprises a passage
3 shape hole ~~(3)~~, and/or the identification code is constituted by an external shape of the platelet
4 ~~(1)~~.

1 3. (Currently Amended) The metal identification platelet ~~(1)~~ as in Claim 2,
2 ~~characterized by the fact, that~~ wherein the hologram ~~(2)~~ and/or shape hole ~~(3)~~ comprises ~~of an~~
3 alphanumeric characters.

1 4. (Currently Amended) The metal identification platelet ~~(1)~~ as in ~~any of the~~
2 Claims 1 ~~to 3~~, ~~characterized by the fact, that~~ wherein the metal ~~used~~ is nickel, with a thickness
3 of 1 to 15 μ m ~~thick~~.

1 5. (Currently Amended) A method of producing an identification platelet ~~(1)~~
2 with ~~the~~ an identification code, ~~characterized by the fact, that it comprises the following~~
3 ~~steps the method comprising:~~
4 forming a shield ~~(9)~~ from an electro-insulation material ~~is formed~~ on a shim ~~(4)~~
5 with a holographic motif ~~(7)~~,
6 then, galvanizing the shim (4) ~~is galvanized~~ in ~~the~~ places not covered by the
7 shield ~~(9)~~ from the electro-insulation material, and

8 **and** removing the completed metal identification platelets ~~(1) are removed~~ from
9 the shim ~~(4)~~.

1 6. (Currently Amended) The method as in Claim 5, ~~characterized by the fact,~~
2 ~~that~~ wherein forming the shield (9) from the electro-insulation material is produced in the
3 following way comprises:

4 applying a photoresist layer ~~(5) is applied~~ on the shim ~~(4)~~ with a holographic
5 motif ~~(7)~~,

6 then putting a mask ~~(6) is put~~ on the photoresist layer ~~(5)~~, **and**
7 exposing the photoresist layer ~~(5)~~ with the mask ~~(6) is exposed~~ by a UV lamp,
8 **and**

9 etching the exposed photoresist layer ~~(5) is etched~~ from the shim ~~(4)~~ in a
10 developer,

11 ~~than~~ then galvanizing the shim ~~(4) is galvanized~~ in the places where the
12 photoresist layer ~~(5)~~ was etched,

13 removing the waste photoresist layer ~~(5) is removed~~, and

14 **and** taking the completed metal identification platelets ~~(1) are taken~~ from the
15 shim ~~(4)~~.

1 7. (Currently Amended) The method as in Claim 5 ~~or 6~~, ~~characterized by the~~
2 ~~fact, that~~ further comprising passivating the shim ~~(4) is passivated~~ by ~~the~~ a solution of
3 potassium dichromate.

1 8. (Currently Amended) The method as in ~~any of the~~ Claims 6 ~~to 7~~,
2 ~~characterized by the fact, that~~ wherein the mask comprises a printing film ~~is used as the mask~~
3 ~~(6)~~.

1 9. (Currently Amended) The method as in ~~any of the~~ Claims 5 ~~to 8~~,
2 ~~characterized by the fact, that~~ wherein the shim ~~(4)~~ is galvanized in a galvanic-plastic nickel
3 bath.

1 10. (Currently Amended) The method as in ~~any of the Claims 5 to 9~~,
2 ~~characterized by the fact, that~~ further comprising:
3 removing the waste shield (9) from the electro-insulation material and/or waste
4 photoresist layer ~~(5) is removed~~ by washing in a solvent, and
5 then washing the shim (4) is washed in ~~demineralised~~ demineralized water and
6 ~~dried~~ drying the shim.

1 11. (Currently Amended) The method as in ~~any of the Claims 5 to 10~~,
2 ~~characterized by the fact, that~~ further comprising removing the completed metal identification
3 platelets ~~(1) are removed~~ from the shim ~~(4)~~ by fine scraping or in an ultrasonic bath.

1 12. (Currently Amended) The method as in ~~any of the Claims 5 to 11~~,
2 ~~characterized by the fact, that~~ wherein the shim ~~(4)~~ with the holographic motif ~~(7)~~ is made
3 from nickel.

1 13. (Currently Amended) The method as in Claim 5, ~~characterized by the fact,~~
2 ~~that~~ further comprising applying the shield (9) from the electro-insulation material ~~is applied~~
3 directly on the shim ~~(4)~~ with the holographic motif ~~(7)~~ using a printing method.

1 14. (Currently Amended) The method as in Claim 13, ~~characterized by the~~
2 ~~fact, that~~ further comprising applying the shield (9) from the electro-insulation material ~~is~~
3 ~~applied~~ using the method of intaglio printing.